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CALCULATIONS OF SURFACE POTENTIAL FOR OXIDE-PASSIVATED HIGH-RESISTIVITY SILICON

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**CALCULATIONS OF SURFACE POTENTIAL  
HIGH-RESISTIVITY**

**$\epsilon$ -PASSIVATED**

**Berkeley, California**

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ABSTRACT

That the oxide-passivated surface of high resistivity silicon is characterized with a high density of donor states is taken into account in calculation of the surface potential.

CALCULATIONS OF SURFACE POTENTIAL FOR  
OXIDE-PASSIVATED HIGH-RESISTIVITY SILICON\*

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Since Kingston and Neustadter,<sup>1</sup> several authors<sup>2</sup> have carried out the numerical computation of the space-charge functions occurring in the description of the electrical behavior of the semiconductor surfaces. Most of these calculations, however, deal with comparatively low surface-charge density and conductivity. But the oxide-passivated surface of high-resistivity silicon is characterized by a high density of donor states giving the charge density of  $10^{-8}$  coulombs/cm<sup>2</sup> or more. This corresponds to a high value of the surface potential compared with the bulk potential, and particularly so for the high-resistivity bulk. In calculating the space-charge functions we can therefore neglect the terms corresponding to the bulk potentials. Also because of the high density of donor states the contribution to the space charge from the holes can be neglected.

The charge density at a point corresponding to a potential  $\phi$  (Fig. 1) in the space-charge region is therefore given by

$$\rho = -q n_i \exp(q\phi/kT) = -q n_i \exp(u)$$

where  $q$  is the electronic charge and  $n_i$  the carrier density in the intrinsic bulk semiconductor. Hence, if we solve Poisson's equation,

$$\frac{d^2 \phi}{dx^2} = - \frac{4\pi\rho}{\epsilon} = \frac{4\pi}{\epsilon} q n_i \exp(u)$$

the surface charge density,  $Q_s$  is given by

$$Q_s = 2 q n_i L_D \exp(u_s/2),$$

and the surface excess is given by

$$\Delta N = 2 n_i L_D \exp(u_s/2),$$

where

$$L_D = (ekT/8\pi q^2 n_i)^{1/2}$$

is the Debye length and  $u_s$  the surface potential in units of  $kT$ . These equations are equivalent to putting  $u_b = 0$  in Kingston and Neustadter's function

$$F(u_s, u_b) = 1/2 [(u_b - u_s) \sinh u_b + \cosh u_s - \cosh u_b]^{1/2}.$$

Assuming  $n_i = 1.5 \times 10^{10} / \text{cm}^3$  and  $L_D = 2.4 \times 10^{-3}$  cm (at 300°k),  $Q_s$  is calculated as a function of  $u_s$  in Fig. 2. For comparison a few of the functions  $F(u_s, u_b)$  have also been shown in Fig. 2.

ACKNOWLEDGMENTS

The author is grateful to the International Atomic Energy Agency, Vienna, for providing a fellowship. He would also like to thank William L. Hansen for his comments in the course of the work.



FOOTNOTE AND REFERENCES

\*Work done under the auspices of the U. S. Atomic Energy Commission.

†IAEA Fellow from Atomic Energy Establishment, Trombay, Bombay, India.

1. R. H. Kingston and S. Neustadter, J. Appl. Phys. 26, 718 (1955).

2. See, for a complete review of the literature, A. R. Plummer,

The Electrochemistry of Semiconductors, Edited by P. J. Holmes

(Academic Press, Inc., New York, 1962).

FIGURE LEGENDS

Fig. 1. Energy-level diagram for silicon-silicon dioxide system.

Fig. 2. Charge density as a function of surface potential. Curve (a) this work; (b)  $F(u_7, u_8)$ , p-bulk, resistivity  $\approx 1000$  ohm-cm; (c)  $F(u_7, u_8)$ , n-bulk, resistivity  $\approx 500$  ohm-cm; (d)  $F(u_6, u_8)$ , n-bulk, resistivity  $\approx 1000$  ohm-cm.

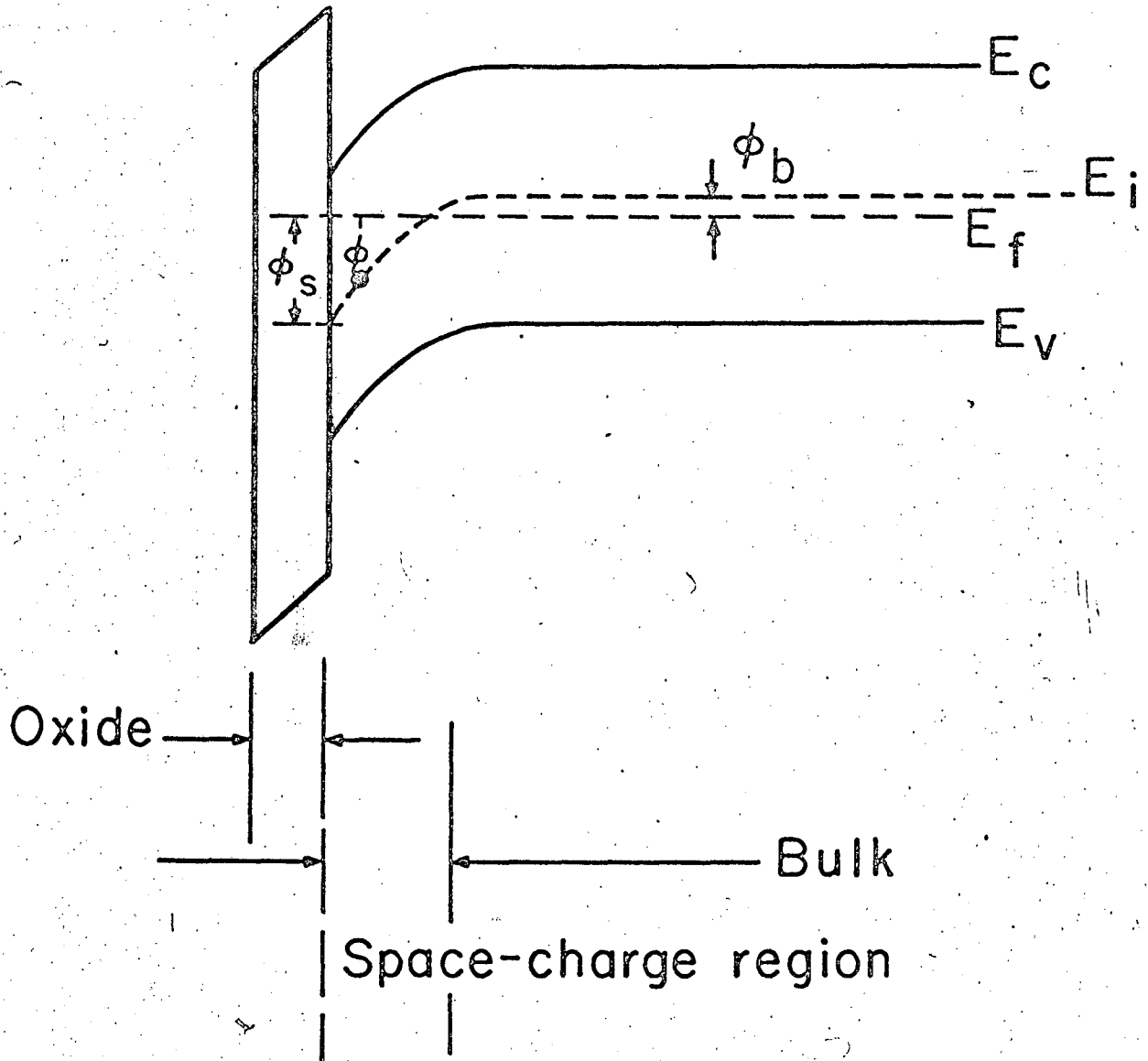


Fig. 1

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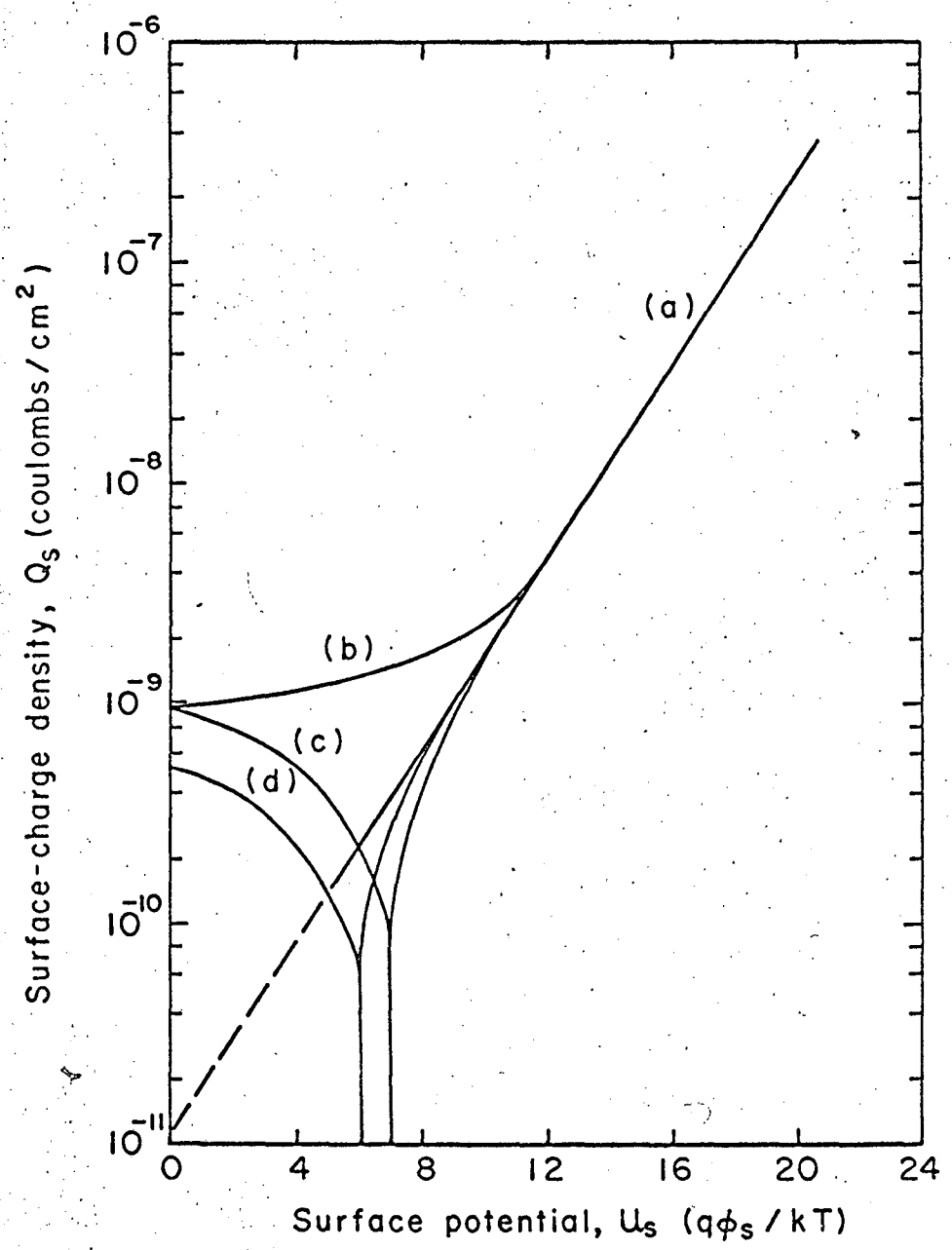


Fig. 2

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